

## **NCE N-Channel Super Trench Power MOSFET**

#### **Description**

The NCEP6060GU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

### **Application**

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

#### **General Features**

- V<sub>DS</sub> =60V,I<sub>D</sub> =60A
  R<sub>DS(ON)</sub>=5.6mΩ (typical) @ V<sub>GS</sub>=10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 150 °C operating temperature
- Pb-free lead plating

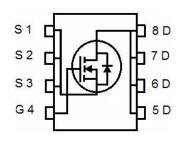
100% UIS TESTED! 100% ΔVds TESTED!

#### **DFN 5X6**





Top View Bottom View



**Schematic Diagram** 

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P6060GU	NCEP6060GU	DFN5X6-8L	-	-	-

#### Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Silicon Limited)	I <sub>D</sub>	60	А
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100°C)	43.5	Α
Pulsed Drain Current	I <sub>DM</sub>	170	Α
Maximum Power Dissipation	P <sub>D</sub>	70	W
Derating factor		0.56	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	320	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	°C

#### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	R <sub>eJC</sub>	1.78	°C/W
Thermal Resistance,Junction-to-Ambient(Note 2)	$R_{ heta JA}$	50	°C/W

# Electrical Characteristics (T<sub>C</sub>=25°Cunless otherwise noted)

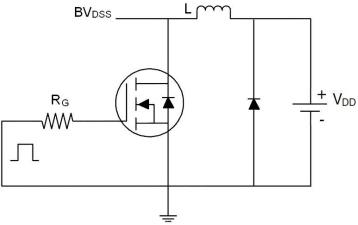
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	60		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)				•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	5.6	7.0	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	35	-	-	S
Dynamic Characteristics (Note4)			•	•		
Input Capacitance	C <sub>lss</sub>	.,	-	1700	-	PF
Output Capacitance	Coss	$V_{DS}$ =30V, $V_{GS}$ =0V,	-	345	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	8	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	8	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =30 $V$ , $I_D$ =20 $A$	-	2	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =4.7 $\Omega$	-	29	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	4	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =30V,I <sub>D</sub> =20A,	-	26.9		nC
Gate-Source Charge	Q <sub>gs</sub>		-	9.4		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	4.6		nC
Drain-Source Diode Characteristics				•		
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	60	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C$ , $I_F = I_S$	-	38		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	48		nC

#### Notes:

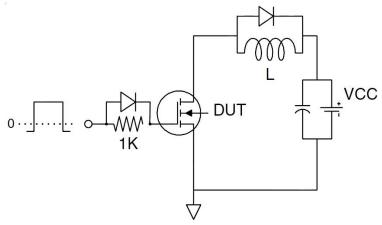
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A$  =25° C. The the maximum allowed junction temperature of 150° C
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}\mathrm{C}$  ,V\_DD=30V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$

### **Test Circuit**

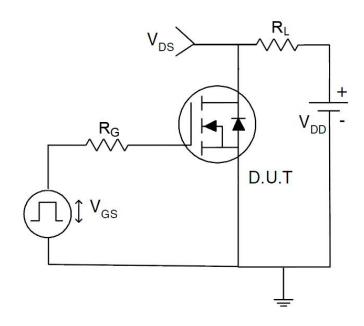
# 1) E<sub>AS</sub> test Circuit



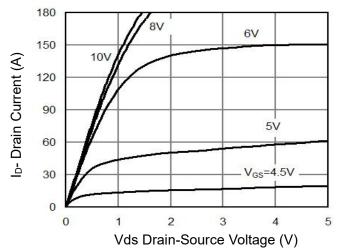
## 2) Gate charge test Circuit



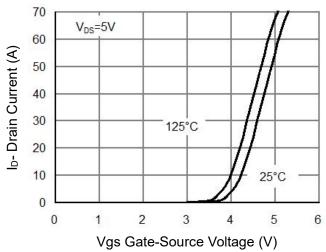
## 3) Switch Time Test Circuit



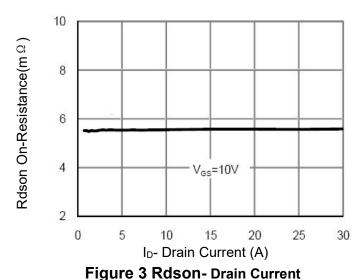
### **Typical Electrical and Thermal Characteristics**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 



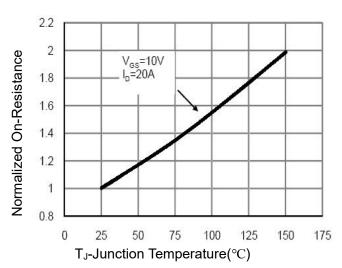


Figure 4 Rdson-JunctionTemperature

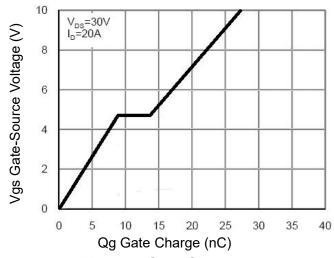


Figure 5 Gate Charge

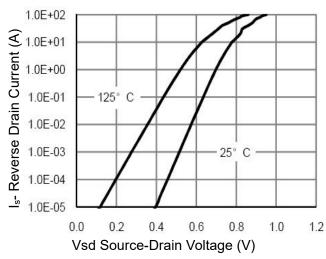


Figure 6 Source- Drain Diode Forward

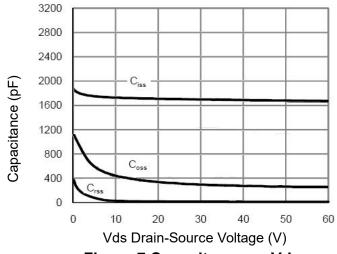


Figure 7 Capacitance vs Vds

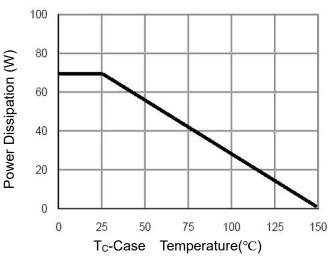


Figure 9 Power De-rating

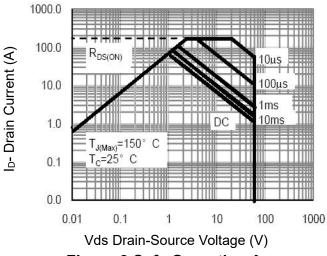


Figure 8 Safe Operation Area

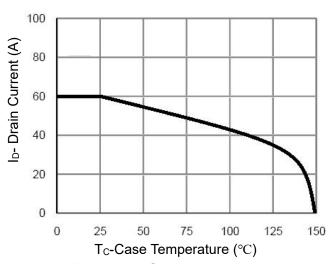
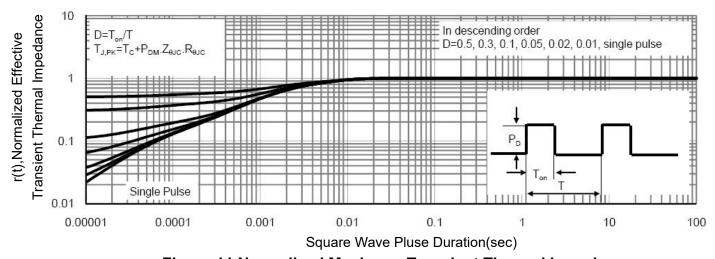
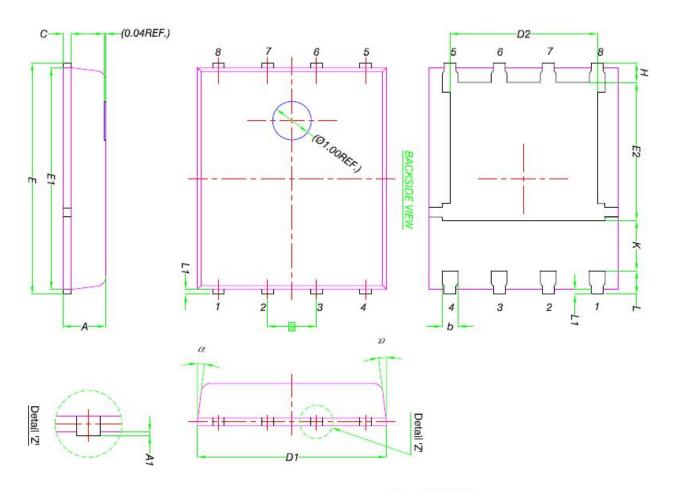


Figure 10 Current De-rating

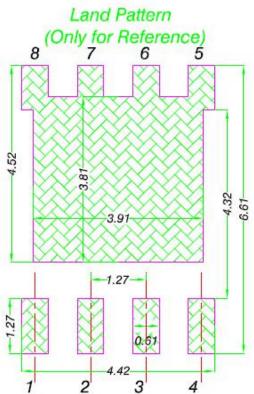


**Figure 11 Normalized Maximum Transient Thermal Impedance** 

# **DFN5X6-8L Package Information**



0/44	MILLIMETERS			
DIM.	MIN.	NOM.	MAX	
Α	0.90	1.00	1.10	
A1	0	-	0.05	
b	0.33	0.41	0.51	
C	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
K	1.10	((*)	-	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	0°	125	12°	



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